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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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STRUCTURE Silicon Monolithic Integrated Circuit

PRODUCT CONSTANT VOLTAGE AND CONSTANT CURRENT

CONTROLLER FOR BATTERY CHARGERS AND ADAPTORS

TYPE BD6551G

FEATURE

· Constant voltage and constant current control

Power supply voltage: 1.8V~12V

High accuracy reference voltage: 1.21V±1%

An accuracy for current-detecting voltage: 200mV±2%

O ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

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PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VMAX	-0.3 ~ 14	V
ICT Pin Maximum Voltage	VICTMAX	-0.3 ~ VCC	V
Power Dissipation	Pd	675 *1	mW
Operating Temperature Range	Topr	0 ~ +85	°C
Maximum Junction Temperature	Tjmax	150	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C

^{*1} Pd derated at 5.4mW/°C for temperature above Ta=25°C, mounted on 70mm × 70mm × 1.6mm glass-epoxy PCB.

O OPERATING CONDITIONS (Ta=0~+85°C)

PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VCC	1.8~12 *2	V

^{*2} Except an amplifier for voltage control loop guaranteed above VCC=2.5V.

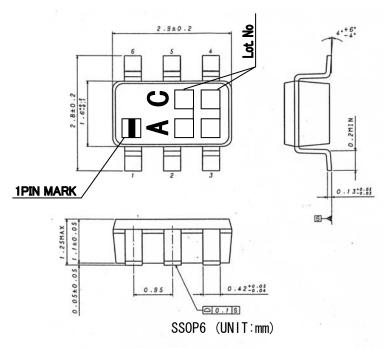


○ ELECTRICAL CHARACTERISTICS (Ta=25°C and Vcc=+5V (unless otherwise specified))

		1				1	
PARAMETER	Symbol	Limit		UNIT	Conditions		
TATOMOLITER	Cymbol	MIN.	TYP.	MAX.	CIVII	Conditions	
[Total Current Consumption]	[Total Current Consumption]						
Total Supply Current - not taking the output sinking current into account	ICC	-	0.6	2	mA	Ta=25°C	
[Voltage Control Loop]							
Transconduction Gain(VCT). Sink Current Only	GMV	1.0	4.5	-	mA/mV	Ta=25°C	
Voltage Control Loop Reference at 1.5mA	VREF	1.198	1.21	1.222	V	Ta=25°C	
sinking current	VNEF	1.186	1.21	1.234		0 < Ta < 85°C	
[Current Control Loop]							
Transconduction Gain(ICT). Sink Current Only	GMI	1.5	3.5	-	mA/mV	Ta=25°C	
Current Control Loop Reference at 2.5mA	VSE	196	200	204	mV	Ta=25°C	
sinking current		192	200	208		0 < Ta < 85°C	
Current out of pin ICT at -200mV	lbi	13	23	33	μΑ	Ta=25°C	
[Output Stage]							
Output Short Circuit Current, Output to VCC, Sink Current Only	IOS	-	25	50	mA	Ta=25°C,OUT=VCC, VSE=0V, ICT=-0.3V	
[UVLO]							
UVLO Threshold Voltage	VVT	1.8	1.9	2.0	V	VCC=L→H	
UVLO Hysteresis Width	DVVT	40	100	160	mV		
Output Short Circuit Current at Full Drive	IOS2	5.0	-	-	mA	Ta=25°C VCC=OUT=1.8V	

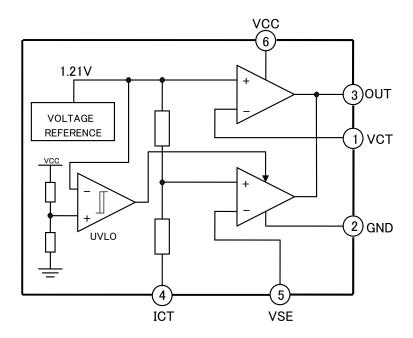
[•] This product is not designed for protection against radio active rays.

O PACKEGE, MARKING SPECIFICATION





O BLOCK DIAGRAM



O PIN No. & PIN NAME

PIN No.	PIN Name	Function	
1	VCT	Input Pin of the Voltage Control Loop	
2	GND	Ground Line. 0V Reference For All Voltages	
3	OUT	Output Pin. Sinking Current Only	
4	ICT	Input Pin of the Current Control Loop(+)	
5	VSE	Input Pin of the Current Control Loop(-)	
6	VCC	Positive Power Supply Line. This pin doubles low voltage input detection pin.	



Operation Notes

1) Absolute maximum ratings

An excess in the absolute maximum rating, such as supply voltage, temperature range of operating conditions, etc., can break down the devices, thus making impossible to identify breaking mode, such as a short circuit or an open circuit. If any over rated values will expect to exceed the absolute maximum ratings, consider adding circuit protection devices, such as fuses.

2) GND voltage

The potential of GND pin must be minimum potential in all condition. As an exception, the circuit design allows voltages up to -0.3 V to be applied to the ICT pin.

3) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

4) Inter-pin shorts and mounting errors

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error or if pins are shorted together.

5) Actions in strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

6) Mutual impedance

Power supply and ground wiring should reflect consideration of the need to lower mutual impedance and minimize ripple as much as possible (by making wiring as short and thick as possible or rejecting ripple by incorporating inductance and capacitance).

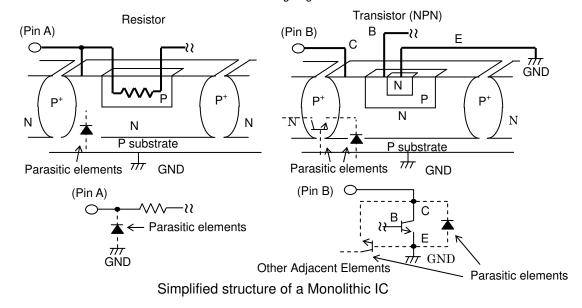
7) Regarding input pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of these P layers with the N layers of other elements, creating a parasitic diode or transistor. For example, as shown in the figures below, the relation between each potential is as follows:

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode.

When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes can occur inevitable in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Accordingly, methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin, should not be used. Although the circuit design allows voltages up to -0.3 V to be applied to the ICT pin, voltages lower than this may cause the behavior described above. Use caution when designing the circuit.



Notes

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